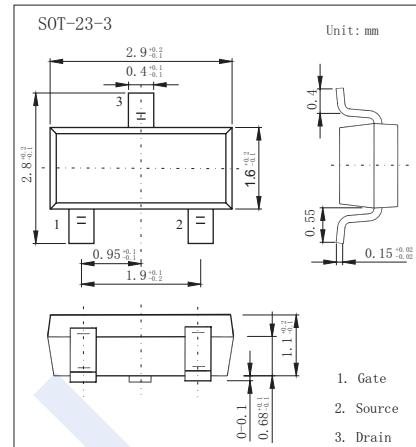
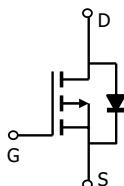


P-Channel Enhancement MOSFET

2SJ3021

■ Features

- $V_{DS} (V) = -30V$
- $I_D = -4.2 A (V_{GS} = -10V)$
- $R_{DS(ON)} < 50m\Omega (V_{GS} = -10V)$
- $R_{DS(ON)} < 65m\Omega (V_{GS} = -4.5V)$
- $R_{DS(ON)} < 120m\Omega (V_{GS} = -2.5V)$



■ Absolute Maximum Ratings $T_a = 25^\circ C$

| Parameter | Symbol | Rating | Unit |
|---|------------|------------|--------------|
| Drain-Source Voltage | V_{DS} | -30 | V |
| Gate-Source Voltage | V_{GS} | ± 12 | |
| Continuous Drain Current $T_a = 25^\circ C$ | I_D | -4.2 | A |
| $T_a = 70^\circ C$ | | -3.5 | |
| Pulsed Drain Current | I_{DM} | -30 | W |
| Power Dissipation $T_a = 25^\circ C$ | P_D | 1.4 | |
| $T_a = 70^\circ C$ | | 1 | |
| Thermal Resistance.Junction- to-Ambient $t \leqslant 10s$ | R_{thJA} | 90 | $^\circ C/W$ |
| Thermal Resistance.Junction- to-Ambient | | 125 | |
| Thermal Resistance.Junction- to-Case | R_{thJC} | 60 | |
| Junction Temperature | T_J | 150 | $^\circ C$ |
| Junction and Storage Temperature Range | T_{stg} | -55 to 150 | |

P-Channel Enhancement MOSFET

2SJ3021

■ Electrical Characteristics $T_a = 25^\circ\text{C}$

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---------------------------------------|--------------|--|------|------|-----------|------------------|
| Drain-Source Breakdown Voltage | V_{DSS} | $I_D=-250\mu\text{A}, V_{GS}=0\text{V}$ | -30 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=-24\text{V}, V_{GS}=0\text{V}$ | | | -1 | μA |
| | | $V_{DS}=-24\text{V}, V_{GS}=0\text{V}, T_J=55^\circ\text{C}$ | | | -5 | |
| Gate-Body leakage current | I_{GSS} | $V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$ | | | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=-250\mu\text{A}$ | -0.4 | | -1.3 | V |
| Static Drain-Source On-Resistance | $R_{DS(on)}$ | $V_{GS}=-10\text{V}, I_D=-4.2\text{A}$ | | | 50 | $\text{m}\Omega$ |
| | | $V_{GS}=-10\text{V}, I_D=-4.2\text{A}, T_J=125^\circ\text{C}$ | | | 75 | |
| | | $V_{GS}=-4.5\text{V}, I_D=-4\text{A}$ | | | 65 | |
| | | $V_{GS}=-2.5\text{V}, I_D=-1\text{A}$ | | | 120 | |
| On state drain current | $I_{D(ON)}$ | $V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$ | -25 | | | A |
| Forward Transconductance | g_{FS} | $V_{DS}=-5\text{V}, I_D=-5\text{A}$ | 7 | 11 | | S |
| Input Capacitance | C_{iss} | $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$ | | 954 | | pF |
| Output Capacitance | C_{oss} | | | 115 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 77 | | |
| Gate resistance | R_g | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$ | | 6 | | Ω |
| Total Gate Charge | Q_g | $V_{GS}=-4.5\text{V}, V_{DS}=-15\text{V}, I_D=-4\text{A}$ | | 9.4 | | nC |
| Gate Source Charge | Q_{gs} | | | 2 | | |
| Gate Drain Charge | Q_{gd} | | | 3 | | |
| Turn-On DelayTime | $t_{d(on)}$ | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=3.6\Omega, R_{GEN}=6\Omega$ | | 6.3 | | ns |
| Turn-On Rise Time | t_r | | | 3.2 | | |
| Turn-Off DelayTime | $t_{d(off)}$ | | | 38.3 | | |
| Turn-Off Fall Time | t_f | | | 12 | | |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F=-4\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 20.2 | | |
| Body Diode Reverse Recovery Charge | Q_{rr} | $I_F=5\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | | 11.2 | | nC |
| Maximum Body-Diode Continuous Current | I_s | | | | -2.2 | A |
| Diode Forward Voltage | V_{SD} | $I_s=-1\text{A}, V_{GS}=0\text{V}$ | | | -1 | V |

■ Marking

| | |
|---------|-----|
| Marking | A1* |
|---------|-----|

P-Channel Enhancement MOSFET

2SJ3021

■ Typical Characteristics

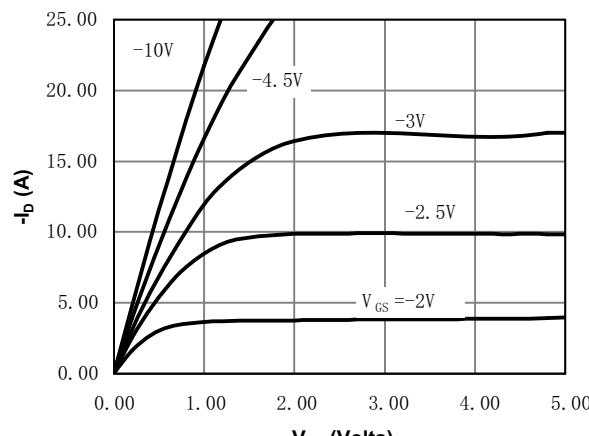


Fig 1: On-Region Characteristics

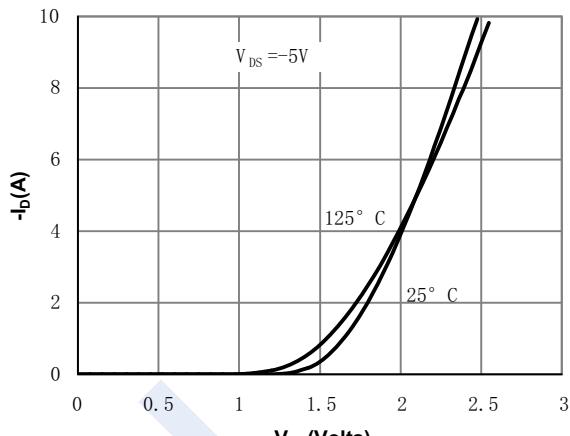


Figure 2: Transfer Characteristics

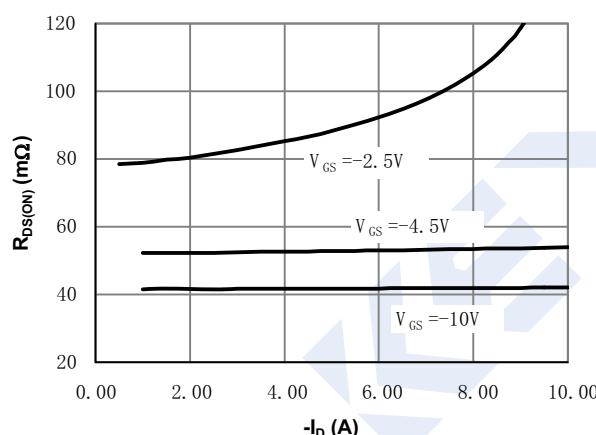


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

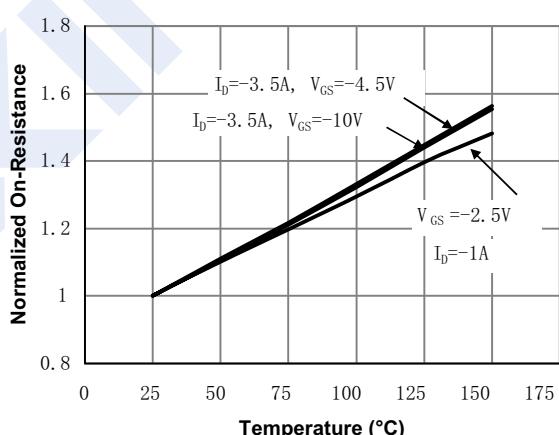


Figure 4: On-Resistance vs. Junction Temperature

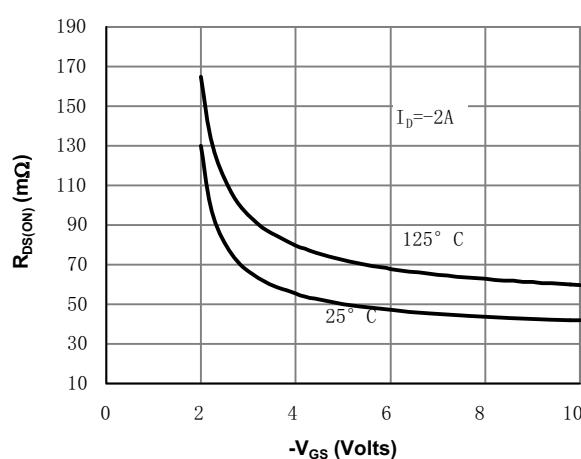


Figure 5: On-Resistance vs. Gate-Source Voltage

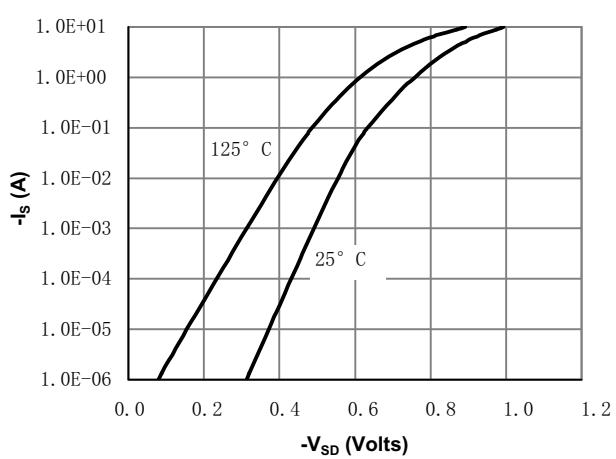


Figure 6: Body-Diode Characteristics

P-Channel Enhancement MOSFET

2SJ3021

■ Typical Characteristics

